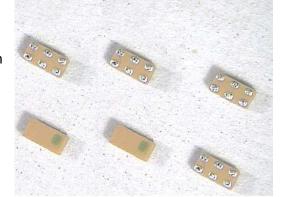


LF 1005 Series

Multilayer Chip Low-Pass Filters

Features

- Ultra small SMD type with low loss at pass-band and high attenuation at stop-band.
- ❖RoHS compliant



Applications

Mobile wireless communication systems, including GSM/WCDMA/LTE phones,etc.

Specifications

Part Number	Frequency Range (MHz)	Insertion Loss @ BW (dB)	VSWR @ BW	Frequency (MHz)	Attenuation (dB)
LF1005- LR83NBA_	698 ~ 960	0.6 max.	2.0 max.	1554~1610	13 min.
				1805~1830	35min.
				2110~2170	35 min.
				1710~2700	30min.

 $\begin{array}{lll} \hbox{Q'ty/Reel (pcs)} & : 10,000 \\ \hbox{Operating Temperature Range} & : -40 \sim +85\,^{\circ}\hbox{C} \\ \hbox{Storage Temperature Range} & : -40 \sim +85\,^{\circ}\hbox{C} \\ \hbox{Storage Period} & : 12 \text{ months max.} \end{array}$

*12 months in vacuum sealed bag and 1 week after opened. Please keep unused parts in vacuum sealed bags.

Solder Paste : SAC 305 type is recommended.

Power Capacity : 2W max.

Part Number

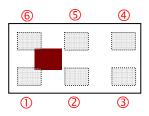
<u>LF</u> 1005 - <u>L</u> R83 NBA □ /<u>LF</u> (S) (6) (7)

① Туре	LF : Low Pass Filter	② Dimensions (L × W)	1.0 × 0.5 mm
3 Material Code	L	Frequency Range	R83=830MHz
Specification Code	NBA	6 Packaging	T: Tape & Reel B: Bulk
Soldering	/LF=lead-free		



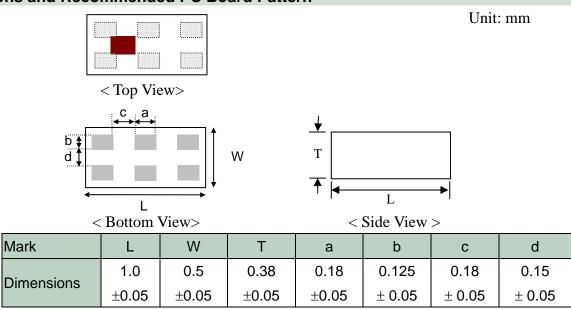
Terminal Configuration

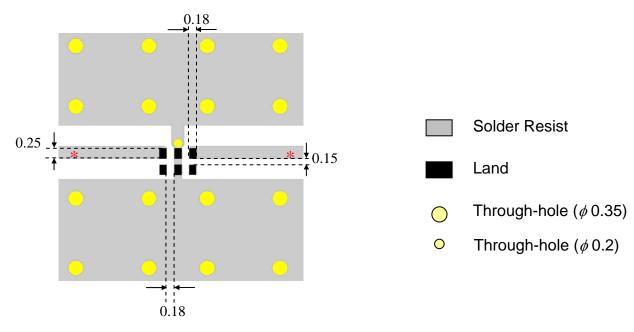
<Top View>



No.	Terminal Name	No.	Terminal Name
①	NC	4	OUT
2	GND	(5)	GND
3	NC	6	IN

Dimensions and Recommended PC Board Pattern

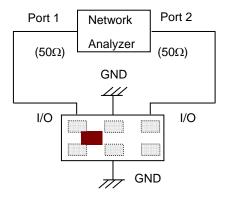




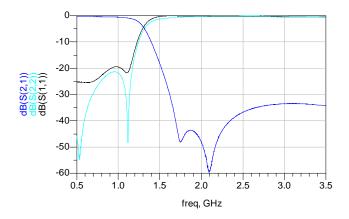
* Line width should be designed to match 50 Ω characteristic impedance, depending on PCB material and thickness.



Measuring Diagram



Typical Electrical Characteristics (T=25°C)



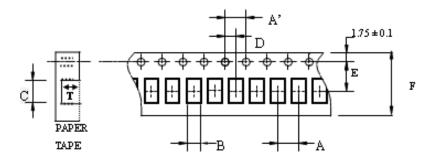
Notes

❖The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.



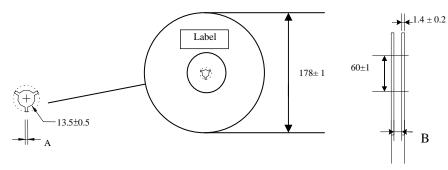
Taping Specifications

❖Tape Dimensions (Unit: mm) & Quantity



Туре	Α	A'	В	С	D	E	F	Т	Quantity/reel	Tape material
1005	2.0±	4.0±	0.62±	1.12±	2.0±	3.5±	8.0±	0.45±	10,000pcs	Donor
1005	0.05	0.1	0.03	0.03	0.05	0.05	0.1	0.03		Paper

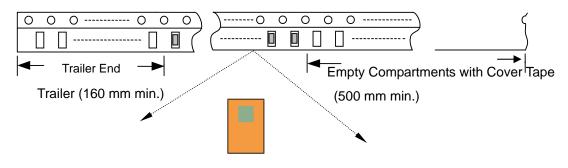
❖Reel Dimensions (Unit: mm)



Label: Customer's Name,
ACX P/N, Q'ty, Date,
ACX Corp.

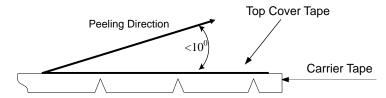
Туре	Α	В	
1005	2.3±0.5	9.0±0.3	

❖Leader and Trailer Tape





❖Peel-off Force



Peel-off force should be in the range of 0.1-0.6~N at a peel-off speed of $300\pm10~mm/min$.

❖Storage Conditions

- (1) Temperature: $5 \sim 35^{\circ}$ C, relative humidity (RH): $45 \sim 75\%$.
- (2) Non-corrosive environment.

Notes

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Mechanical & Environmental Characteristics

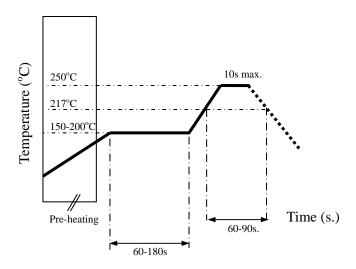
Item	Requirements	Procedure		
Solder ability	 No apparent damage More than 75% of the terminal electrode shall be covered with new solder. 	 Preheat: 120± 5 °C Solder: 245± 5°C for 5± 1 sec 		
Soldering strength (Termination Adhesion)	1. 3N minimum	 Solder specimen onto test jig. Apply push force at 0.5mm/s until electrode pads are peeled off or ceramic are broken. Pushing force is applied to longitude direction 		
Deflection (Substrate Bending)	 No apparent damage Fulfill the electrical specification 	 Solder specimen onto test jig (FR4, 0.8mm) using the recommend soldering profile. Apply a bending force of 2mm deflection Pressure Rod 90mm		
Heat/Humidity Resistance	No apparent damage Fulfill the electrical specification after test	 Temperature: 85± 2°C Humidity: 90% ~ 95% RH Duration: 1000±48hrs Recovery: 1-2hrs 		
Thermal shock (Temperature Cycle)	No apparent damage Fulfill the electrical specification after test	 One cycle/step 1 : 125 ± 5°C for 30 min step 2 : - 40 ± 5°C for 30 min No of cycles : 100 Recovery:1-2 hrs 		
Low Temperature Resistance	No apparent damage Fulfill the electrical specification after test	 Temperature: -40± 5 °C Duration: 500 ±24hrs Recovery: 1-2hrs 		



Soldering Conditions

❖Typical Soldering Profile for Lead-free Process

Reflow Soldering:



Notes

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